- Electrically Identical to SN54LS86A/SN74LS86A
- Mechanically Identical to SN54L86/SN74L86
- Total Average Propagation Delay Times . . . 10 ns
- Typical Total Power Dissipation . . . 30.5 mW

FUNCTION TABLE (EACH GATE)

INP	UTS	ОИТРИТ
Α	В	OOTPOT
L	L	L
L	Н	н
н	Ł	н
н	H	L

H = high level L = low level

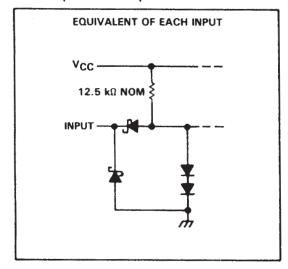
logic symbol[†]

(1)		
1A (1)	=1	(3)
1B (2)		17
6/1		(4)
2B (6)		2Y
2B (8)		
-14		(10)
(9)		3Y
38		
4A (12)		(11)
(13)		44
4B (13)		
		ı

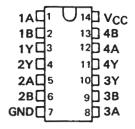
 $^{^\}dagger \text{This}$ symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

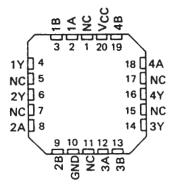
schematics of inputs and outputs



SN54LS386A . . . J OR W PACKAGE SN74LS386A . . . D OR N PACKAGE (TOP VIEW)

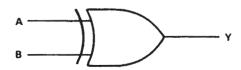


SN54LS386A . . . FK PACKAGE (TOP VIEW)



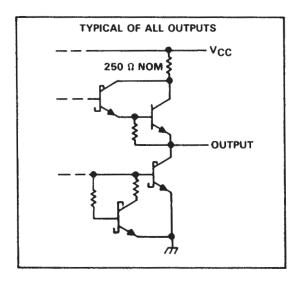
NC - No internal connection

logic diagram (each gate)



positive logic

$$Y = A \oplus B = \overline{A}B + A\overline{B}$$



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)				•										7	٧
Input voltage														7	V
Operating free-air temperature range:	SN54LS386A										5	5°c	C to	125°	С
	SN74LS386A											0	°C t	o 70°	С
Storage temperature range															

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN	54LS38	36A	SN	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	GIVIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-400			-400	μΑ
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†			154LS38	86A	SN			
PARAMETER				TYP‡	MAX	MIN	TYP [‡]	MAX	UNIT
VIH High-level input voltage			2			2			V
VIL Low-level input voltage					0.7			8.0	٧
V _{IK} Input clamp voltage	V _{CC} = MIN,	I ₁ = -18 mA			-1.5			-1.5	V
VOH High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max	V _{1H} = 2 V, x, I _{OH} = -400 μA	2.5	3.4		2.7	3.4		V
VOI Low-level output voltage	V _{CC} = MIN. V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
TOE BON OUT OUT OF TORON	VIL = VIL max	IOL = 8 mA					0.35	0.5	
I ₁ Input current at maximum input voltage	VCC = MAX,	V1 = 7 V			0.2			0.2	mA
IIH High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V			40			40	μА
IL Low-level input current	V _{CC} = MAX,	V _I = 0.4 V			-0.8			-0.8	mA
IOS Short-circuit output current§	V _{CC} = MAX	***************************************	- 20		- 100	- 20		- 100	mA
ICC Supply current	VCC = MAX,	See Note 2		6.1	10		6.1	10	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	FROM (INPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	A or B	Other input low C _L = 15	15.55	12	23	200
^t PHL	7018	R _L = 2	1	10	17	ns
^t PLH	A or B	Other input high See Not	i i	20	30	ns
t _{PHL}	000	Other input mgm See Not		13	22	1

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

[§]Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with the inputs grounded and the outputs open.

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